Product Summary (Typ. @ $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ )

| $\mathbf{V}_{\mathrm{DSS}}$ | $\mathbf{R}_{\mathrm{DS}(\mathbf{n})}$ | $\mathbf{Q}_{\mathbf{g}}$ | $\mathbf{Q}_{\mathbf{g d}}$ | $\mathbf{I D}_{\mathbf{D}}$ |
| :---: | :---: | :---: | :---: | :---: |
| -12 V | $85 \mathrm{~m} \Omega$ | 3.7 nC | 0.6 nC | -2.6 A |

## Description

This new generation MOSFET is designed to minimize the on-state resistance ( $\mathrm{R}_{\mathrm{DS}(o n)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

- Battery Management
- Load Switch
- Battery Protection


## Features

- LD-MOS Technology with the Lowest Figure of Merit:
$R_{D S(o n)}=85 \mathrm{~m} \Omega$ to Minimize On-State Losses
$Q_{g}=3.7 n C$ for Ultra-Fast Switching
- $\quad \mathrm{V}_{\mathrm{gs}(\mathrm{th})}=-0.6 \mathrm{~V}$ typ. for a Low Turn-On Potential
- CSP with Footprint $1.0 \mathrm{~mm} \times 1.0 \mathrm{~mm}$
- Height $=0.62 \mathrm{~mm}$ for Low Profile
- $\quad E S D=3 k V$ HBM Protection of Gate
- Totally Lead-Free \& Fully RoHS Compliant (Notes 1 \& 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability


## Mechanical Data

- Case: U-WLB1010-4
- Terminal Connections: See Diagram Below
- Weight: 0.005 grams (Approximate)

U-WLB1010-4


Top View Equivalent Circuit

Ordering Information (Note 3)

| Part Number | Case | Packaging |
| :---: | :---: | :---: |
| DMP1096UCB4-7 | U-WLB1010-4 | $3000 /$ Tape \& Reel |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) \& 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine ( $<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl}$ ) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## Marking Information



1W = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: X = 2010)
$M=$ Month (ex: $9=$ September)


BW = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: X = 2010)
$M=$ Month (ex: $9=$ September)


DMP1096UCB4

Maximum Ratings ( $@ \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic |  |  | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Drain-Source Voltage | $\mathrm{V}_{\mathrm{DSS}}$ | -12 | V |  |  |
| Gate-Source Voltage | $\mathrm{V}_{\mathrm{GSS}}$ | -5 | V |  |  |
| Continuous Drain Current (Note 5) $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}$ | Steady <br> State | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{D}}$ | -2.6 |
| -2.1 | A |  |  |  |  |
| Continuous Drain Current (Note 5) $\mathrm{V}_{\mathrm{GS}}=-2.5 \mathrm{~V}$ | Steady <br> State | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{D}}$ | -2.4 |
| Pulsed Drain Current (Note 6) | I | -1.9 | A |  |  |

## Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Power Dissipation (Note 5) | $\mathrm{P}_{\mathrm{D}}$ | 0.82 | W |
| Thermal Resistance, Junction to Ambient @ $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}($ Note 5) | $\mathrm{R}_{\theta \mathrm{JJA}}$ | 150 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range | $\mathrm{T}_{\mathrm{J}, \mathrm{T}} \mathrm{T}_{\text {SG }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics ( ( $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 7) |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | BV ${ }_{\text {DSS }}$ | -12 | - | - | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |
| Gate-Source Breakdown Voltage | BVGSS | -6.0 | - | - | V | $V_{D S}=0 V, I_{G}=-250 \mu \mathrm{~A}$ |
| Zero Gate Voltage Drain Current $\mathrm{T}_{\mathrm{J}}=+25^{\circ} \mathrm{C}$ | IDSS | - | - | -1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DS}}=-9.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |
| Gate-Source Leakage | IGSs | - | - | -500 | nA | $\mathrm{V}_{\mathrm{GS}}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| ON CHARACTERISTICS (Note 7) |  |  |  |  |  |  |
| Gate Threshold Voltage | $\mathrm{VGS}_{\text {G(th) }}$ | -0.4 | -0.6 | -1.0 | V | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |
| Static Drain-Source On-Resistance | R ${ }_{\text {DS ( }}^{\text {( }}$ ( $)$ | - | 85 | 102 | $\mathrm{m} \Omega$ | $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{ID}=-500 \mathrm{~mA}$ |
|  |  | - | 97 | 116 |  | $\mathrm{V}_{\mathrm{GS}}=-2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-500 \mathrm{~mA}$ |
|  |  | - | 127 | 152 |  | $\mathrm{V}_{\mathrm{GS}}=-1.5 \mathrm{~V}, \mathrm{ID}_{\mathrm{D}}=-500 \mathrm{~mA}$ |
| Forward Transfer Admittance | $\left\|\mathrm{Y}_{\mathrm{fs}}\right\|$ | - | 4 | - | S | $\mathrm{V}_{\mathrm{DS}}=-6 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-500 \mathrm{~mA}$ |
| Diode Forward Voltage | $V_{S D}$ |  | -0.6 | -1.0 | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=-500 \mathrm{~mA}$ |
| DYNAMIC CHARACTERISTICS (Note 8) |  |  |  |  |  |  |
| Input Capacitance | Ciss | - | 251 | - | pF | $\begin{aligned} & \mathrm{V}_{\mathrm{DS}}=-6 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \\ & \mathrm{f}=1.0 \mathrm{MHz} \end{aligned}$ |
| Output Capacitance | Coss | - | 359 | - |  |  |
| Reverse Transfer Capacitance | $\mathrm{Crss}^{\text {r }}$ | - | 70 | - |  |  |
| Total Gate Charge | $\mathrm{Q}_{\mathrm{g}}$ | - | 3.7 | - | nC | $\begin{aligned} & \mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-6 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{D}}=-500 \mathrm{~mA} \end{aligned}$ |
| Gate-Source Charge | $\mathrm{Q}_{\mathrm{gs}}$ | - | 0.4 | - |  |  |
| Gate-Drain Charge | $\mathrm{Q}_{\mathrm{gd}}$ | - | 0.6 | - |  |  |
| Gate Charge at Vth | $\mathrm{Q}_{\mathrm{g}(\mathrm{th})}$ | - | 0.2 | - |  |  |
| Turn-On Delay Time | tD(on) | - | 17.6 | - | ns | $\begin{aligned} & \mathrm{V}_{\mathrm{DS}}=-6 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=-2.5 \mathrm{~V}, \\ & \mathrm{R}_{\mathrm{G}}=20 \Omega, \mathrm{I}_{\mathrm{D}}=-500 \mathrm{~mA} \end{aligned}$ |
| Turn-On Rise Time | $\mathrm{tr}_{\mathrm{r}}$ | - | 26.9 | - |  |  |
| Turn-Off Delay Time | $t_{\text {( } \text { (off) }}$ | - | 37.5 | - |  |  |
| Turn-Off Fall Time | $\mathrm{tf}_{f}$ | - | 32.3 | - |  |  |

[^0]

Fig. 1 Typical Output Characteristic



Fig. 5 On-Resistance Variation with Temperature
Fig. 3 Typical On-Resistance s. Drain Current and Gate Voltage


Fig. 2 Typical Transfer Characteristic


Fig. 4 Typical On-Resistance vs. Drain Current and Temperature


Fig. 6 On-Resistance Variation with Temperature

## PMPES



Fig. 7 Gate Threshold Variation vs. Ambient Temperature


Fig. 9 Typical Total Capacitance

$\mathrm{t}_{1}$, PULSE DURATION TIME (s)
Fig. 11 Transient Thermal Response

DMP1096UCB4

## Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.


| U-WLB1010-4 |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |  |  |
| D | 0.95 | 1.05 | 1.00 |  |  |
| E | 0.95 | 1.05 | 1.00 |  |  |
| A | - | 0.62 | - |  |  |
| A2 | - | - | 0.38 |  |  |
| b | 0.25 | 0.35 | 0.30 |  |  |
| E | - | - | 0.50 |  |  |
| SD | - | - | 0.25 |  |  |
| SE | - | - | 0.25 |  |  |
| All Dimensions in $\mathbf{~ m m ~}$ |  |  |  |  |  |

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.


| Dimensions | Value (in mm) |
| :---: | :---: |
| C | 0.50 |
| D | 0.25 |

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[^0]:    Notes: $\quad$ 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
    6. Repetitive rating, pulse width limited by junction temperature.
    7. Short duration pulse test used to minimize self-heating effect.
    8. Guaranteed by design. Not subject to production testing.

